



Product Change Notification

Change Notification #: 117149 - 00
Change Title: Intel® NUC Kit, NUC6CAYH,
Intel® NUC Kit, NUC6CAYS,
PCN 117149-00, Product Design,
BIOS Update and Image Update
Date of Publication: September 10, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	September 27, 2019
Date of First Availability of Post-Conversion Material:	September 27, 2019

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

The Intel® NUC Kit SKUs listed in the products affected table below will have the following changes.

1. The BIOS will be updated from version AY0060 to AY0063. BIOS update is to enhance product performance. A complete list of BIOS changes can be found in the BIOS release notes. The BIOS updates and release notes can be found at <http://downloadcenter.intel.com>.
2. The Windows® 10 Image is being updated to Windows® 10 version 19H1 S Mode. It is only apply to BOXNUC6CAYSAJ and BOXNUC6CAYSJL.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS and Windows Revision Update to ensure smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implication to our customers.

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXNUC6CAYSJL	950794	J26849-409	J50857-409	J26849-410	J50857-410
BOXNUC6CAYSJ	950796	J26847-409	J26842-409	J26847-410	J26842-410
BOXNUC6CAYHL	950798	J26845-409	J23203-408	J26845-410	J23203-409
BOXNUC6CAYH	950804	J26843-409	J23203-408	J26843-410	J23203-409

PCN Revision History:

Date of Revision:

September 10, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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